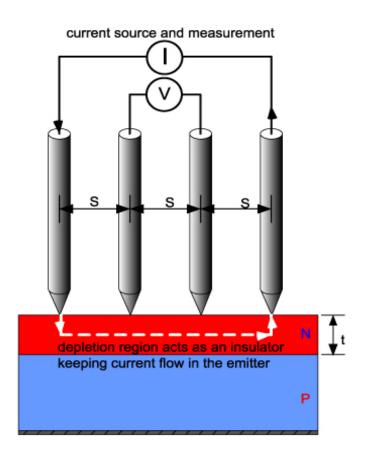
Lab Report III Finding the resistivity using 4 probs

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Objective: Use probe4 resistivity and measure the sheet resistivity (ohm-cm) of a **Si** sample. By knowing the sheet resistance we can calculate the resistivity with multiplying the thinness of the sheet

Theory:

The sheet resistivity of the top emitter layer is very easy to measure experimentally using a "four point probe". A current is passed through the outer probes and induces a voltage in the inner voltage probes. The junction between the n and p-type materials behaves as an insulating layer and the cell must be kept in the dark.



Procedure:

Let's take a p-type Si wafer which is having 2 inch diameter and thickness 500 micro meters.



Signatone four probe resistivity meter has 4 probes and these probes are collinear , with the help of inner two probes we measure the current and remaining two use to measure voltage. Ratio of voltage and current gives the resistivity of the sample. Current in the inner probes flows in the order of mille or micro amps.

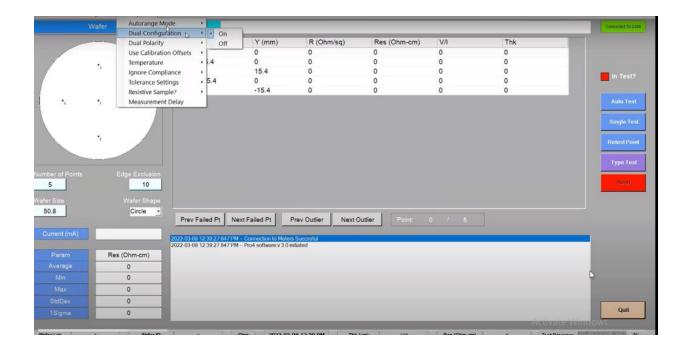
Following picture is 2410 Source meter which is used for probing current and voltage simultaneously. It can detect up to $1100\,\mathrm{v}$.



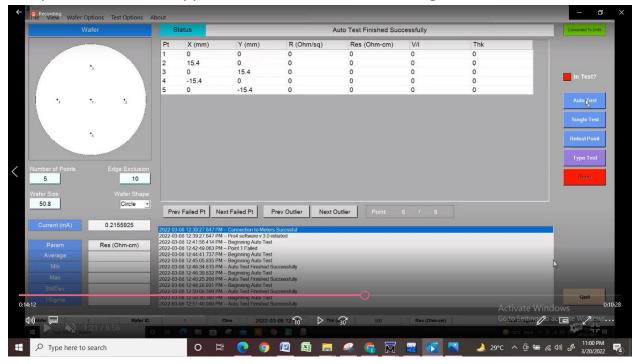


- → While takeing the measurements these 4 probes have to be tight contact with si wafer surface.
- → Software used here is probe4

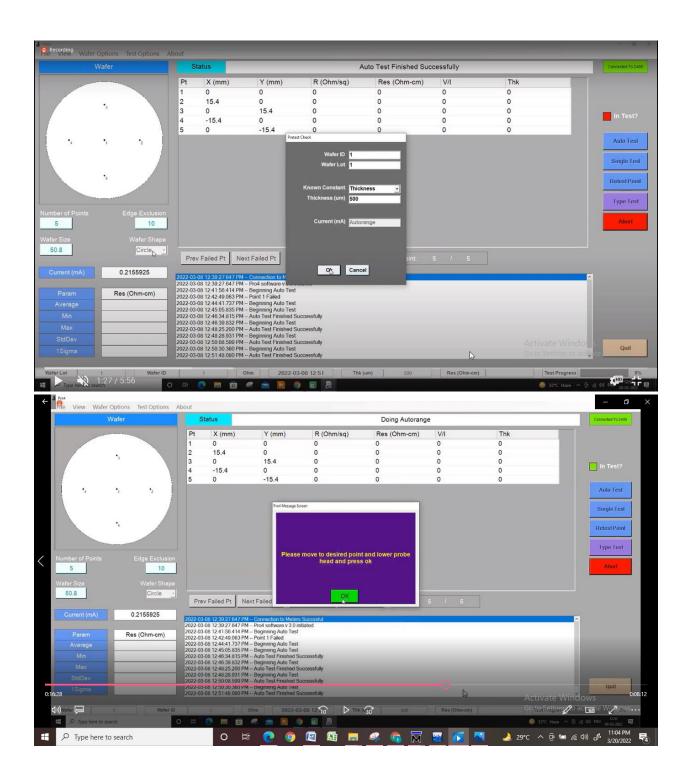
 Various options available in prob4 interface.



Auto range mode is selects range of currents from micro amps to mill amps, and measures voltages. We use NIST certified calibration, dual configuration is to choose the either positive or negative type of current. Complacence value is upper limit of the current or voltage to measure.



Single test:





Single Test results:

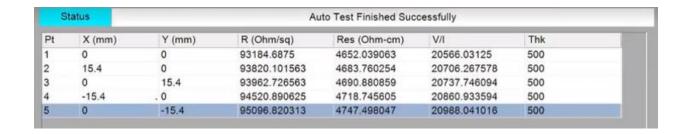
Pt	X (mm)	Y (mm)	R (Ohm/sq)	Res (Ohm-cm)	V/I	Thk	
1	0	0	91262.070313	4556.056641	20141.705078	500	
2	15.4	0	0	0	0	0	
3	0	15.4	0	0	0	0	
4	-15.4	0	0	0	0	0	
5	0	-15.4	0	0	0	0	

Auto test:

Here we are performing 5 point measurements. So, each time have to move the point when following message displace.



Test results for auto test:



Type test:

Here we need to make sure that 4 probes contact with si wafer.



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